

SEA & LAND ELECTRONIC CORP.

www.sealand-pptc.com

APPROVAL SHEET

MODELNO	OMD400.40.0V	
MODEL NO.:	nSMD100-13.2V	
CUSTOMER:		
CUSTOMER'S APPR	OVAL:	
AUTHORIZED SIGNA	TURE/STAMP:	
DATE		
MANUFACTURER:		
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SEA & LAND ELECTRONIC CORP.

Submitted by:

Approved by: DATE:



nSMD100-13.2V

Features

- Surface Mount Devices
- Lead free device
- Size 3.2*1.6 mm/0.12*0.06 inch
- Surface Mount packaging for automated assembly

Application

protected, including:

Almost anywhere there is a low voltage power supply, up to 60V and a load to be

- Computer mother board, Modern. USB hub
- PDAs & Charger, Analog & digital line card
- Digital cameras, Disk drivers, CD-ROMs,

Performance Specification

Model	Maulina	V_{max}	I _{max}	I _{hold}	I _{trip}	P_d	Maximum Time To Trip		Resis	tance	Agency .	Approval
Wodei	Marking			@25°C	@25°C	Max.	Current	Time	Ri _{min}	R1max	UL	TUV
		(Vdc)	(A)	(A)	(A)	(W)	(A)	(Sec)	(Ω)	(Ω)	OL	101
nSMD100-13.2V	α H	13.2	100	1.00	1.80	0.6	8.00	0.30	0.055	0.270		

Ihold = Hold Current. Maximum current device will not trip in 25°C still air.

Itrip = Trip Current. Minimum current at which the device will always trip in 25°C still air.

Vmax = Maximum operating voltage device can withstand without damage at rated current (Imax).

Imax = Maximum fault current device can withstand without damage at rated voltage (Vmax).

Pd = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.

Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C.

R1_{max} = Maximum device resistance is measured one hour post reflow.

CAUTION: Operation beyond the specified ratings may result in damage and possible arcing and flame.

Environmental Specifications

Test	Conditions	Resistance change
Passive aging	+85°C, 1000 hrs.	±5% typical
Humidity aging	+85°C, 85% R.H., 168 hours	±5% typical
Thermal shock	+85°C to -40°C, 20 times	±33% typical
Resistance to solvent	MIL-STD-202,Method 215	No change
Vibration	MIL-STD-202,Method 201	No change
Ambient operating conditions :	- 40 °C to 85 °C	
Maximum surface temperature of the co	levice in the tripped state is 125 °C	

Agency Approvals : UL pending

Regulation/Standard: (Pb)

PN RoHS

2002/95/EC

HF

EN14582

Ibold Versus Temperature

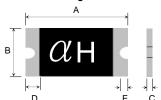
ihold versus remperan	116									
Maximum ambient operating temperature (T _{mao}) vs. hold current (I _{hold}) Model										
Model	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C	
nSMD100-13.2V	1 45	1.31	1 15	1.00	0.84	0.77	0.69	0.61	0.48	

nSMD100-13.2V

Construction And Dimension (Unit:mm)

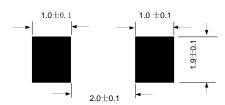
Model	`	A	В				D	E	
Wodel	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.	
nSMD100-13.2V	3.00	3.50	1.50	1.80	0.50	1.20	0.15	0.10	

Dimensions & Marking



α = Trademark H = Part identification

Recommended Pad Layout (mm)



Termination Pad Characteristics

Terminal pad materials:

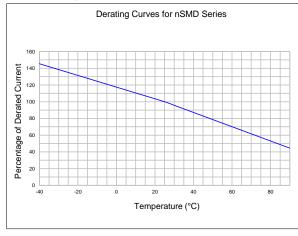
Tin-plated Nickel-Copper

Terminal pad solderability: Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

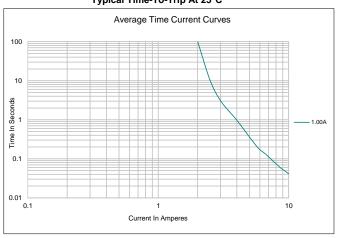
Rework

Use standard industry practices, the removal device must be replaced with a fresh one.

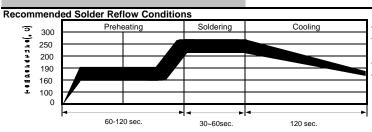
Thermal Derating Curve



Typical Time-To-Trip At 25°C



nSMD100-13.2V

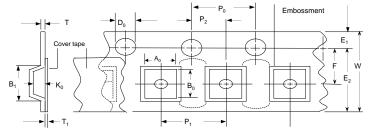


- · Recommended reflow methods: IR, vapor phase oven, hot air oven.
- Devices are not designed to be wave soldered to the bottom side of the board.
- Recommended maximum paste thickness is 0.25 mm (0.010 inch).
- Devices can be cleaned using standard method and solvents.
- Note: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

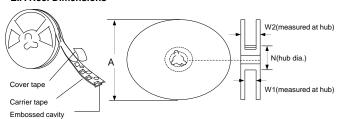
Tape And Reel Specifications (mm)

Governing Specifications	EIA 481-1
W	8.15 ± 0.3
P0	4.0 ± 0.10
P1	4.0 ± 0.10
P2	2.0 ± 0.05
A0	1.95 ± 0.10
B0	3.45 ± 0.10
B1max.	4.35
D0	1.5 + 0.1, -0
F	3.5 ± 0.05
E1	1.75 ± 0.10
E2min.	6.25
Tmax.	0.6
T1max.	0.1
K0	1.04 ± 0.1
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	178
N min.	60
W1	9 ± 0.5
W2	12.6 ± 0.5

EIA Tape Component Dimensions



EIA Reel Dimensions



Storage And Handling

- Storage conditions : 40°C max, 70% R.H.
- Devices may not meet specified performance if storage conditions are exceeded.

Order Information Packaging nSMD 100 -13.2V Tape & Reel Quantity Product name Hold Max Size 3216 mm / 1206 inch Current Voltage 3500 pcs/reel SMD: surface mount device 1.00A 3500 pcs/reel

Tape & reel packaging per EIA481-1

Labeling Information

